

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>HAO-SU ZHANG</td> <td>12/27/2012</td> </tr> <tr> <td>JUN ZHU</td> <td>12/27/2012</td> </tr> <tr> <td>QUN-QING LI</td> <td>12/27/2012</td> </tr> <tr> <td>GUO-FAN JIN</td> <td>12/27/2012</td> </tr> <tr> <td>SHOU-SHAN FAN</td> <td>12/27/2012</td> </tr> </tbody> </table>		Name	Execution Date	HAO-SU ZHANG	12/27/2012	JUN ZHU	12/27/2012	QUN-QING LI	12/27/2012	GUO-FAN JIN	12/27/2012	SHOU-SHAN FAN	12/27/2012
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<table border="1"> <tr> <td>Name:</td> <td>Tsinghua University</td> </tr> <tr> <td>Street Address:</td> <td>No. 1, Qinghua Yuan, Haidian District</td> </tr> <tr> <td>City:</td> <td>Beijing</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> </table>		Name:	Tsinghua University	Street Address:	No. 1, Qinghua Yuan, Haidian District	City:	Beijing	State/Country:	CHINA				
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
Fax Number:	7147357469												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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ATTORNEY DOCKET NUMBER:

US45065

NAME OF SUBMITTER:

Clifford O. Chi

Total Attachments: 2

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. HAO-SU ZHANG , residing at Beijing, China
- 2. JUN ZHU , residing at Beijing, China
- 3. QUN-QING LI , residing at Beijing, China
- 4. GUO-FAN JIN , residing at Beijing, China
- 5. SHOU-SHAN FAN , residing at Beijing, China
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **TSINGHUA UNIVERSITY** having a principal place of business at **No.1, Qinghua Yuan, Haidian District, Beijing City, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66,Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METHOD FOR MAKING LIGHT EMITTING DIODE** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Zhang Haosu</u> HAO-SU ZHANG	<u>Dec.27,2012</u> Date
2.	<u>Jun Zhu</u> JUN ZHU	<u>Dec.27,2012</u> Date
3.	<u>Li Qunqing</u> QUN-QING LI	<u>Dec.27,2012</u> Date
4.	<u>Guofan Jin</u> GUO-FAN JIN	<u>Dec.27,2012</u> Date
5.	<u>Shou-Shan Fan</u> SHOU-SHAN FAN	<u>Dec.27,2012</u> Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date